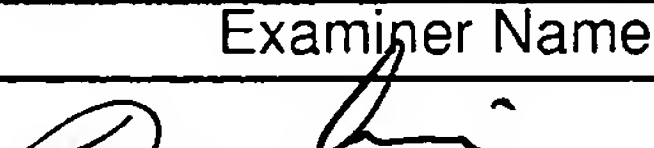


<b>INFORMATION DISCLOSURE CITATION</b> <i>(Use several sheets if necessary)</i>				ATTY DOCKET NO. FIS920040098US1		APPLICATION NO. 10/711,076		
				Bernier et al.				
				FILING 8/20/04		GROUP ART Unknown		
<b>U.S. PATENT DOCUMENTS</b>								
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
<b>U.S. PATENT APPLICATION PUBLICATIONS</b>								
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
<b>FOREIGN PATENT DOCUMENTS</b>								
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
DF		2001127103	11/05/01	Japan				
<b>OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)</b>								
EXAMINER <i>Da Shin</i>					DATE CONSIDERED 9/15/05			
<small>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</small>								

# ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	COMPRESSIBLE FILMS SURROUNDING SOLDER CONNECTORS						
<p>Application Number :</p> <p>Confirmation Number:</p> <p>First Named Applicant: William Bernier</p> <p>Attorney Docket Number: FIS920040098US1</p> <p>Art Unit:</p> <p>Examiner:</p> <p>Search string: ( 6483191 or 5274913 or 6281452 or 6573122 or 6100114 or 20030230792 ).pn</p>							
<b>US Patent Documents</b>							
<b>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</b>							
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
DP	1	6483191	2002-11-19	Umezaki			
	2	5274913	1994-01-04	Grebe et al			
	3	6281452	2001-08-28	Prasad et al			
	4	6573122	2003-06-03	Standing			
BP	5	6100114	2000-08-08	Milkovich et al			
<b>US Published Applications</b>							
<b>Note: Applicant is not required to submit a paper copy of cited US Published Applications</b>							
init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
DP	1	20030230792	2003-12-18	Wu et al			
<b>Signature</b>							
Examiner Name				Date			
				9/5/05			